

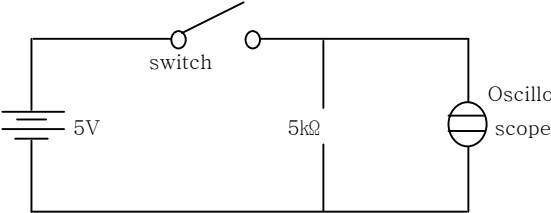
TACT SWITCH SPECIFICATION

1. GENERAL

- 1-1 Switch action : PUSH - ON type S.P.S.T
 1-2 Switch rating : DC 12V, 50mA Max
 1-3 Operation temperature range : -20 °C ~ 70 °C
 1-4 Preservative temperature range : -30 °C ~ 80 °C
 1-5 Appearance and dimensions : See outside drawing page
 1-6 Standard conditions : Unless otherwise specified, the test and measurements shall be carried out as follows.
 Ambient temperature : 5 °C ~ 35 °C
 Relative humidity : 45 ~ 85% RH
 Air pressure : 86 ~106 kPa (860~1060mbar)
 However, if doubt arises on the decision based in the measured values under the above-mentioned conditions, the following conditions shall be employed
 Ambient temperature : 20±2°C
 Relative humidity : 65±5% RH
 Air pressure : 86 ~106 kPa (860~1060mbar)

2. PERFORMANCE

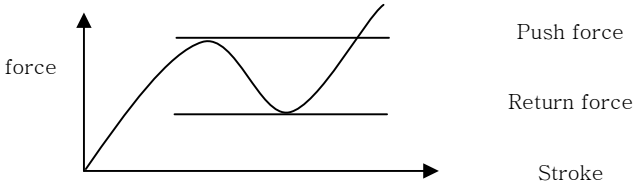
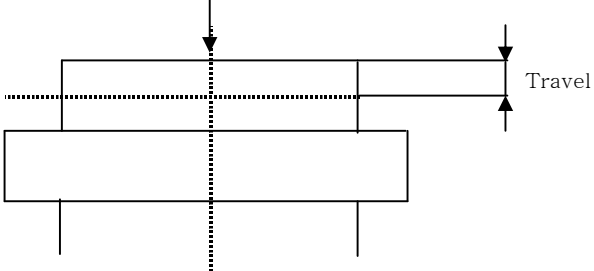
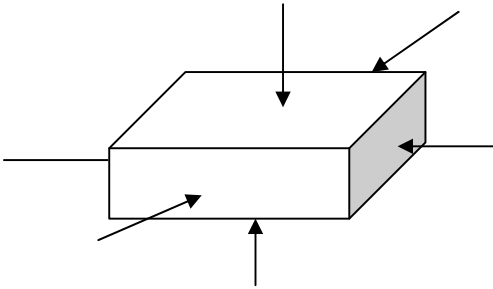
2-1 Electrical characteristics

N O	I T E M	TEST CONDITIONS	PERFORMANCE
2.1.1	Contact resistance	Applying a static load twice the actuating force to the center of the stem, measurements shall be made with a 1KHz small-current contact resistance meter.	<u>100</u> mΩ max
2.1.2	Insulation resistance	Measurements shall be made following application of DC <u>100</u> V potential across terminals and across terminals and frame for one minute.	<u>100</u> MΩ min
2.1.3	Dielectric withstanding votage	AC <u>250</u> V(50Hz or 60Hz) shall be applied across terminals and across terminals and frame for one minute	There shall be no breakdown
2.1.4	Bounce	Lightly striking the center of the stem at a rate encountered in normal use (3 to 4 operations per sec) bounce shall be tested at "ON" and "OFF" 	<u>10</u> msec max

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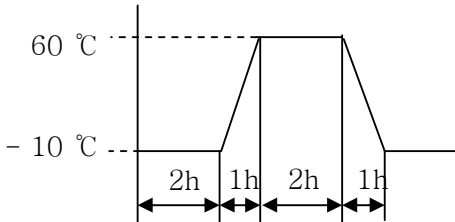
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2-2 Mechanical characteristics

N O	I T E M	TEST CONDITIONS	PERFORMANCE
2.2.1	Operation force	Push by recommended operating condit 	Push force <u>$180 \pm 50\text{gf}$</u>
2.2.2	Travel	Push by recommended operating condition $F = (\text{Operation force}) \times 2$ 	<u>$0.2 \pm 0.1 \text{ mm}$</u>
2.2.3	Stop strength	Astatic load of <u>3 kgf</u> shall be applied in the direction stem operation for a period of 60 seconds.	No damage (Electrical and mechanical)
2.2.4	Stop strength	The maximum force to withstand a pull applied opposite to the ddirection of stem operation shall be measured.	<u>1 kgf</u> min
2.2.5	Vibration tast	1) Amplitude : 1.5mm 2) Sweep rate : 10-55-10Hz for 1 minute. 3) Sweep method : Lofarethmic frequency sweep rate. 4) Vibration direction : X.Y.Z (3 directions) 5) Time : Each direction 2 hours (Total 6 hours)	No 2.1 and 2.2.1 to 2.2.2 shall be satisfied
2.2.6	Impact shock test	1) Acceleration : 80G 2) Cycles of test : 3 cyles each in 6 directions, for a total 18 cycles 	No 2.1 and 2.2.1 to 2.2.2 shall be satisfied
2.2.7	Soldering heat test	Soldering area : $t/2$ of P.W.B thickness (P.W.B : $t = 1.6$) Soldering temperature : $260 \pm 5 ^\circ\text{C}$ Soldering time : $5 \pm 1 \text{ sec}$	No damage (Electrical and mechanical)

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2-3 Climatic characteristics

N O	I T E M	TEST CONDITIONS	PERFORMANCE
2.3.1	Cold test	1) Temperature : $-30 \pm 2^{\circ}\text{C}$ 2) Duration of test : 96 hours 3) Take off a drop water 4) Standard condition after test : 1 hour	Contact resistance : 200 MΩ Max No 2.1.2 to 2.1.4 and 2.2.1 to 2.2.2 shall be satisfied.
2.3.2	Heat test	1) Temperature : $80 \pm 2^{\circ}\text{C}$ 2) Duration of test : 96 hours 3) Standard conditions after test : 1 hour	Contact resistance : 200 MΩ Max No 2.1.2 to 2.1.4 and 2.2.1 to 2.2.2 shall be satisfied.
2.3.3	Temperature cycle	1) Test cycles : 5 cycles 2) Standard conditions after test : 1 hour 3) 1 cycle : 	Contact resistance : 200 MΩ Max No 2.1.2 to 2.1.4 and 2.2.1 to 2.2.2 shall be satisfied.
2.3.4	Humidity test	1) Temperature : $60 \pm 2^{\circ}\text{C}$ 2) Relative humidity : 90 ~ 95 % 3) Duration of test : 96 hours 4) Take off a drop water 5) Standard conditions after test : 1 hour	Contact resistance : 200 MΩ Max No 2.1.2 to 2.1.4 and 2.2.1 to 2.2.2 shall be satisfied.
2.3.5	Operating life test	1) DC 5V, 5mA Resistance load 2) Operation speed : 2~3 cycles / sec 3) Push force : Maximum value of operation force (300g) 4) Cycles of operation : <u>100,000 cycles</u>	Contact resistance : 200 MΩ Max Bounce : 20 m sec max Actuating force : $\pm 30\%$ initial force No 2.1.2 to 2.1.3 and 2.2.2 shall be satisfied.
2.3.6	Withstand H ₂ S	1) Density : 3 ± 2 ppm 2) Temperature : $40 \pm 2^{\circ}\text{C}$ 3) Relative humidity : 90 ~ 95 % 4) Duration of test : 24 hours 5) Standard conditions after test : 1 hour	Contact resistance : 200 MΩ Max No 2.1.2 to 2.1.4 and 2.2.1 to 2.2.2 shall be satisfied.
2.3.7	Withstand SO ₂	1) Density : 10 ± 2 ppm 2) Temperature : $40 \pm 2^{\circ}\text{C}$ 3) Relative humidity : 90 ~ 95 % 4) Duration of test : 24 hours 5) Standard conditions after test : 1 hour	Contact resistance : 200 MΩ Max No 2.1.2 to 2.1.4 and 2.2.1 to 2.2.2 shall be satisfied.

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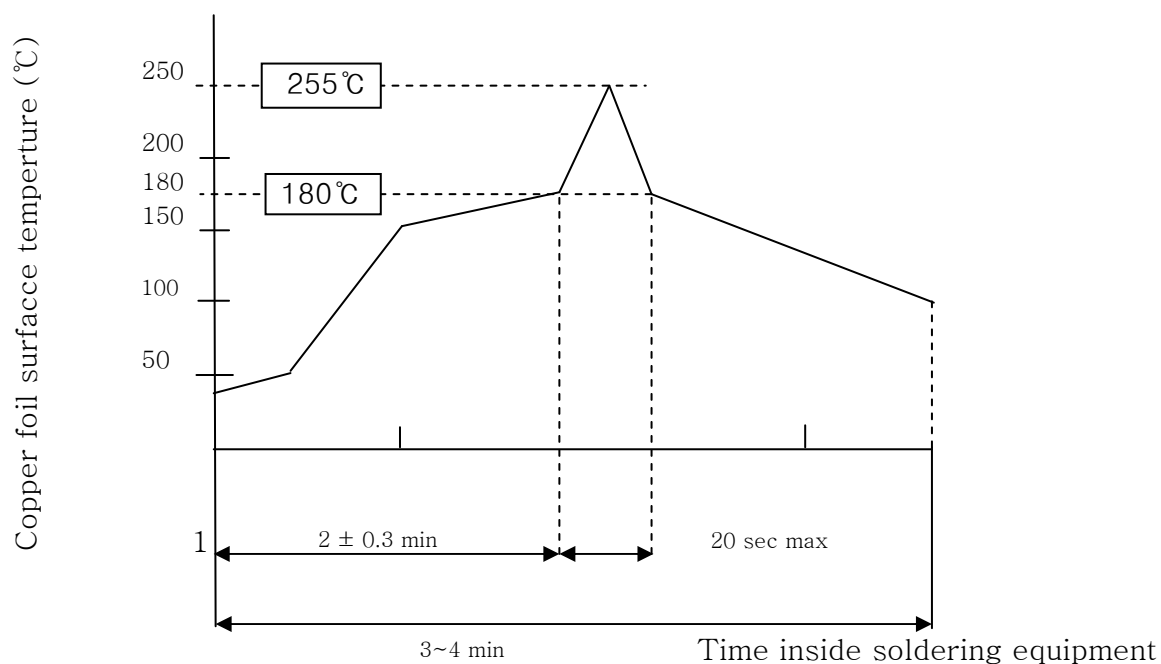
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3. SOLDERING

Reflow soldering conditions

Preheat : Temperature on the copper foil surface should reach 180 °C, 2±0.3 minutes after the P.W.B entered into the soldering equipment.

Soldering heat : Temperature on the copper foil surface should reach the peak temperature of 260 °C within 20 seconds after the P.W.B entered into soldering heat zone.



Temperature Profile

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